

Item	Qty	Reference	Part Description	Manufacture / Part #
1	1	CD1	Cap., X5R 2.2uF 10V 10%	AVX 0612ZD225KAT2A
2	1	JP2	Headers, Dbl. Row 1mm Ctrs.	CommConn Con Inc. 6250S-06G1
3	1	XJP2	Shunt, 1mm Ctrs.	CommConn Con Inc. CTAIJ1MM-RYY-G1
4	4	P101	Pin, Printed Circuit	Mill Max 9081-0-00-15-00-00-08-0
5	0	RS1 (Opt)	Res., 1206 TBD	
6	1	RS2	Resistor, Chip 10 0.25W 5%	AAC CR18-100JM
7	0	TP1 (Opt)	Testpoint, Test pad	Component Corp. TP-107-02
8	1	UD1	I.C., Low Pwr. Resistor Set Osc.	Linear Tech. Corp. LTC6906CS6
9	1	XUD1	Blister Pack, Anti-Static	Linear Tech. Corp. 59-5935
10	1		FAB, PRINTED CIRCUIT BOARD	DEMO CIRCUIT #814C-H
11	1		STENCIL	STENCIL 814C

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